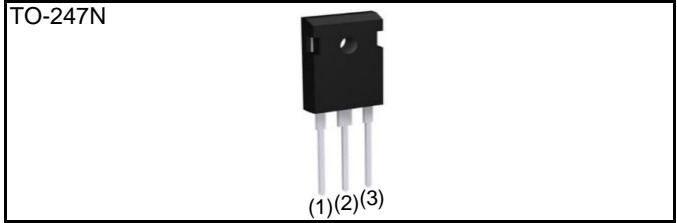
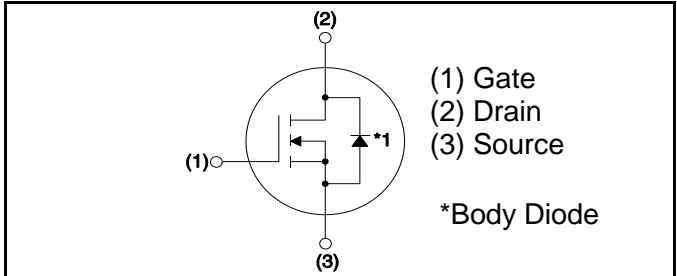


|                     |       |
|---------------------|-------|
| $V_{DSS}$           | 1200V |
| $R_{DS(on)}$ (Typ.) | 160mΩ |
| $I_D^{*1}$          | 17A   |
| $P_D$               | 103W  |

### ●Outline



### ●Inner circuit



### ●Features

- 1) Qualified to AEC-Q101
- 2) Low on-resistance
- 3) Fast switching speed
- 4) Fast reverse recovery
- 5) Easy to parallel
- 6) Simple to drive
- 7) Pb-free lead plating ; RoHS compliant

### ●Application

- Automobile
- Switch mode power supplies

### ●Packaging specifications

|      |                           |           |
|------|---------------------------|-----------|
| Type | Packing                   | Tube      |
|      | Reel size (mm)            | -         |
|      | Tape width (mm)           | -         |
|      | Basic ordering unit (pcs) | 30        |
|      | Taping code               | C11       |
|      | Marking                   | SCT3160KL |

### ●Absolute maximum ratings ( $T_{vj} = 25^{\circ}C$ unless otherwise specified)

| Parameter   | Symbol               | Value       | Unit        |   |
|---|----------------------|-------------|-------------|---|
| Drain - Source Voltage                                | $V_{DSS}$            | 1200        | V           |   |
| Continuous Drain current                              | $T_c = 25^{\circ}C$  | $I_D^{*1}$  | 17          | A |
|   | $T_c = 100^{\circ}C$ | $I_D^{*1}$  | 12          | A |
| Pulsed Drain current ( $T_c = 25^{\circ}C$ )          | $I_{D,pulse}^{*2}$   | 42          | A           |   |
| Gate - Source voltage (DC)                            | $V_{GSS}$            | -4 to +22   | V           |   |
| Gate - Source surge voltage ( $t_{surge} < 300nsec$ ) | $V_{GSS,surge}^{*3}$ | -4 to +26   | V           |   |
| Recommended drive voltage                             | $V_{GS,op}^{*4}$     | 0 / +18     | V           |   |
| Virtual Junction temperature                          | $T_{vj}$             | 175         | $^{\circ}C$ |   |
| Range of storage temperature                          | $T_{stg}$            | -55 to +175 | $^{\circ}C$ |   |

●Electrical characteristics (T<sub>vj</sub> = 25°C unless otherwise specified)

| Parameter                                   | Symbol                            | Conditions   | Values       |            |          | Unit |
|---|-----------------------------------|--|--------------|------------|----------|------|
|   |                                   |  | Min.         | Typ.       | Max.     |      |
| Drain - Source breakdown voltage            | V <sub>(BR)DSS</sub>              | V <sub>GS</sub> = 0V, I <sub>D</sub> = 1mA<br>T <sub>vj</sub> = 25°C<br>T <sub>vj</sub> = -55°C    | 1200<br>1200 | -<br>-     | -<br>-   | V    |
| Zero Gate voltage Drain current             | I <sub>DSS</sub>                  | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 1200V<br>T <sub>vj</sub> = 25°C<br>T <sub>vj</sub> = 150°C | -<br>-       | 1<br>2     | 10<br>-  | μA   |
| Gate - Source leakage current               | I <sub>GSS+</sub>                 | V <sub>GS</sub> = +22V, V <sub>DS</sub> = 0V   | -            | -          | 100      | nA   |
| Gate - Source leakage current               | I <sub>GSS-</sub>                 | V <sub>GS</sub> = -4V, V <sub>DS</sub> = 0V  | -            | -          | -100     | nA   |
| Gate threshold voltage                      | V <sub>GS(th)</sub>               | V <sub>DS</sub> = 10V, I <sub>D</sub> = 2.5mA  | 2.7          | -          | 5.6      | V    |
| Static Drain - Source on - state resistance | R <sub>DS(on)</sub> <sup>*5</sup> | V <sub>GS</sub> = 18V, I <sub>D</sub> = 5A<br>T <sub>vj</sub> = 25°C<br>T <sub>vj</sub> = 150°C    | -<br>-       | 160<br>272 | 208<br>- | mΩ   |
| Gate input resistance                       | R <sub>G</sub>                    | f = 1MHz, open drain   | -            | 18         | -        | Ω    |

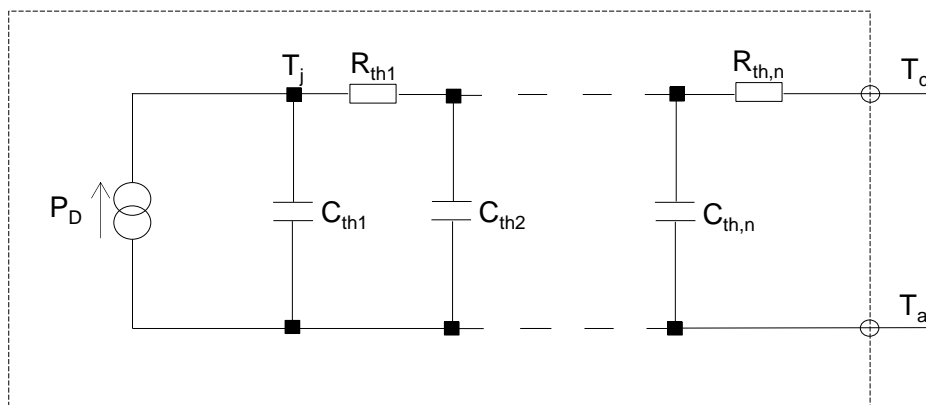
●Thermal resistance

| Parameter                           | Symbol            | Values |      |      | Unit |
|-------------------------------------|-------------------|--------|------|------|------|
|                                     |                   | Min.   | Typ. | Max. |      |
| Thermal resistance, junction - case | R <sub>thJC</sub> | -      | 1.12 | 1.46 | K/W  |

●Typical Transient Thermal Characteristics

| Symbol           | Value    | Unit |
|------------------|----------|------|
| R <sub>th1</sub> | 1.11E-01 | K/W  |
| R <sub>th2</sub> | 7.09E-01 |      |
| R <sub>th3</sub> | 3.01E-01 |      |

| Symbol           | Value    | Unit |
|------------------|----------|------|
| C <sub>th1</sub> | 8.73E-04 | Ws/K |
| C <sub>th2</sub> | 5.10E-03 |      |
| C <sub>th3</sub> | 2.94E-02 |      |



● **Electrical characteristics** ( $T_{vj} = 25^{\circ}\text{C}$  unless otherwise specified)

| Parameter                                    | Symbol            | Conditions  | Values |      |      | Unit          |
|--|-------------------|---|--------|------|------|---------------|
|  |                   |   | Min.   | Typ. | Max. |               |
| Transconductance                             | $g_{fs}^{*5}$     | $V_{DS} = 10\text{V}, I_D = 5\text{A}$  | -      | 2.5  | -    | S             |
| Input capacitance                            | $C_{iss}$         | $V_{GS} = 0\text{V}$  | -      | 398  | -    | pF            |
| Output capacitance                           | $C_{oss}$         | $V_{DS} = 800\text{V}$  | -      | 41   | -    |               |
| Reverse transfer capacitance                 | $C_{rss}$         | $f = 1\text{MHz}$   | -      | 18   | -    |               |
| Effective output capacitance, energy related | $C_{o(er)}$       | $V_{GS} = 0\text{V}$<br>$V_{DS} = 0\text{V to } 600\text{V}$  | -      | 45   | -    | pF            |
| Total Gate charge                            | $Q_g^{*5}$        | $V_{DS} = 600\text{V}$<br>$I_D = 5\text{A}$   | -      | 42   | -    | nC            |
| Gate - Source charge                         | $Q_{gs}^{*5}$     | $V_{GS} = 18\text{V}$   | -      | 10   | -    |               |
| Gate - Drain charge                          | $Q_{gd}^{*5}$     | See Fig. 1-1.   | -      | 22   | -    |               |
| Turn - on delay time                         | $t_{d(on)}^{*5}$  | $V_{DS} = 400\text{V}$<br>$I_D = 5\text{A}$   | -      | 14   | -    | ns            |
| Rise time                                    | $t_r^{*5}$        | $V_{GS} = 0\text{V}/+18\text{V}$  | -      | 18   | -    |               |
| Turn - off delay time                        | $t_{d(off)}^{*5}$ | $R_G = 0\Omega$<br>$R_L = 80\Omega$   | -      | 24   | -    |               |
| Fall time                                    | $t_f^{*5}$        | See Fig. 1-1, 1-2.  | -      | 25   | -    |               |
| Turn - on switching loss                     | $E_{on}^{*5}$     | $V_{DS} = 600\text{V}$<br>$V_{GS}=0\text{V}/18\text{V}, I_D = 5\text{A}$<br>$R_G = 0\Omega, L = 750\mu\text{H}$         | -      | 62   | -    | $\mu\text{J}$ |
| Turn - off switching loss                    | $E_{off}^{*5}$    | $E_{on}$ includes diode reverse recovery<br>$L_{\sigma} = 50\text{nH}, C_{\sigma} = 200\text{pF}$<br>See Fig. 2-1, 2-2. | -      | 12   | -    |               |

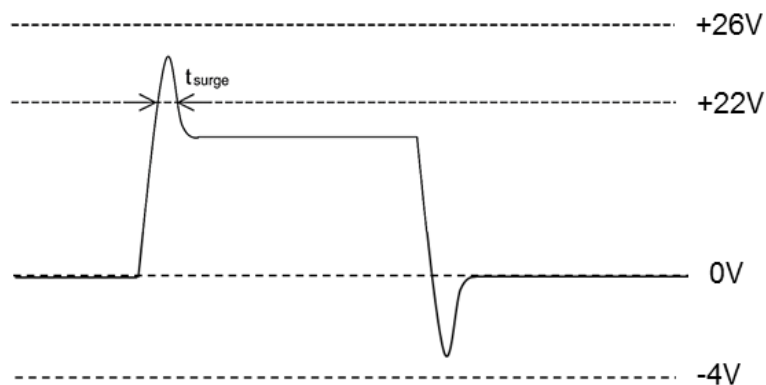
● **Body diode electrical characteristics** (Source-Drain) ( $T_{vj} = 25^{\circ}\text{C}$  unless otherwise specified)

| Parameter                              | Symbol         | Conditions  | Values |      |      | Unit |
|--|----------------|---|--------|------|------|------|
|  |                |   | Min.   | Typ. | Max. |      |
| Body diode continuous, forward current | $I_S^{*1}$     | $T_c = 25^{\circ}\text{C}$  | -      | -    | 17   | A    |
| Body diode direct current, pulsed      | $I_{SM}^{*2}$  |   | -      | -    | 42   | A    |
| Forward voltage                        | $V_{SD}^{*5}$  | $V_{GS} = 0\text{V}, I_S = 5\text{A}$   | -      | 3.2  | -    | V    |
| Reverse recovery time                  | $t_{rr}^{*5}$  | $I_F = 5\text{A}$<br>$V_R = 600\text{V}$<br>$di/dt = 1100\text{A}/\mu\text{s}$<br>$L_{\sigma} = 50\text{nH}, C_{\sigma} = 200\text{pF}$<br>See Fig. 3-1, 3-2. | -      | 13   | -    | ns   |
| Reverse recovery charge                | $Q_{rr}^{*5}$  |   | -      | 26   | -    | nC   |
| Peak reverse recovery current          | $I_{rrm}^{*5}$ |   | -      | 4    | -    | A    |

\*1 Limited by maximum  $T_{vj}$  and for Max.  $R_{thJC}$ .

\*2  $PW \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*3 Example of acceptable  $V_{GS}$  waveform



\*4 Please be advised not to use SiC-MOSFETs with  $V_{GS}$  below 13V as doing so may cause thermal runaway.

\*5 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

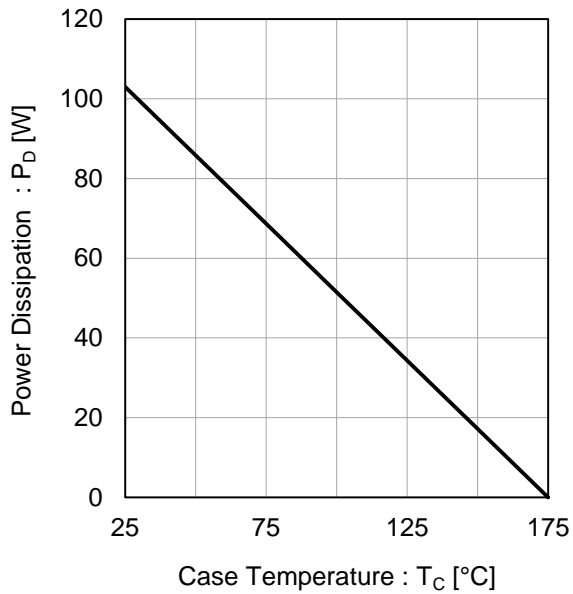


Fig.2 Maximum Safe Operating Area

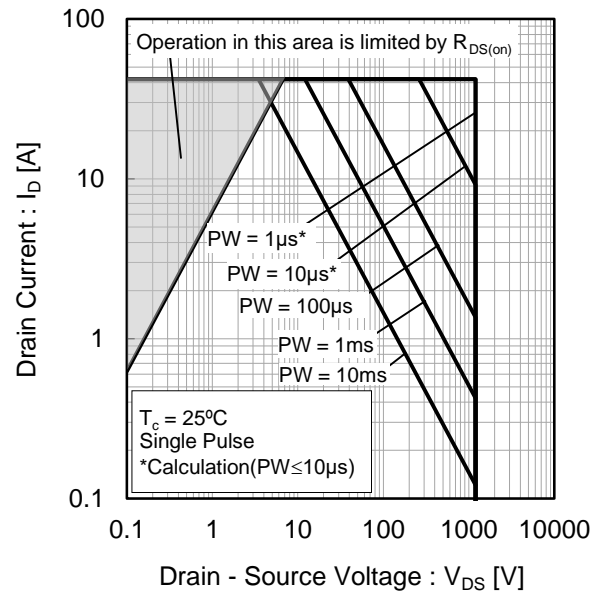
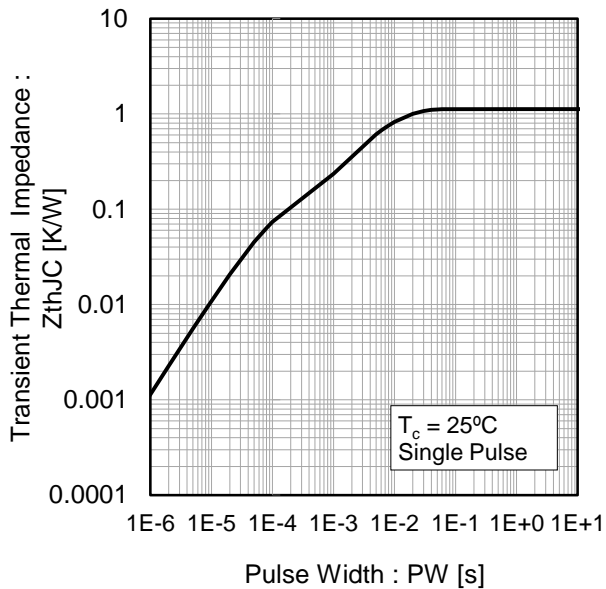


Fig.3 Typical Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Typical Output Characteristics(I)

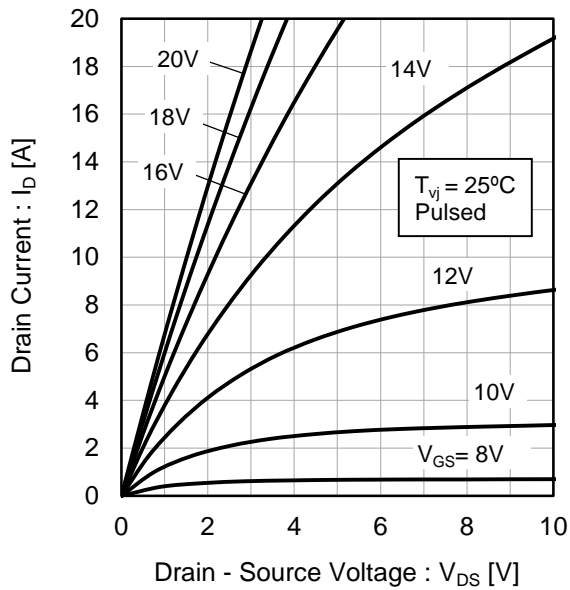


Fig.5 Typical Output Characteristics(II)

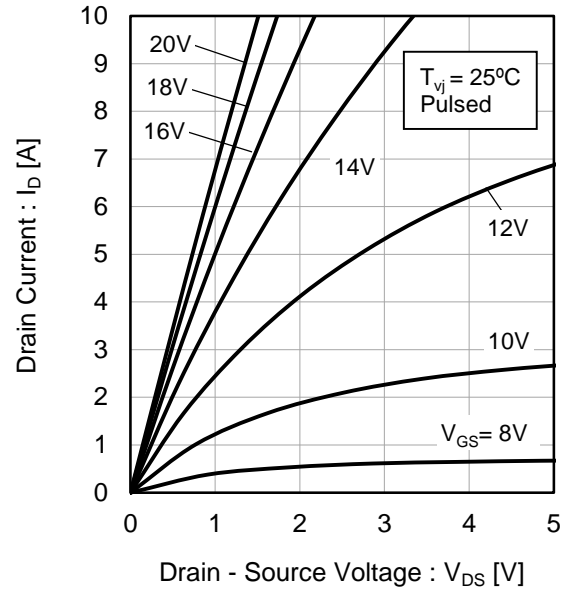
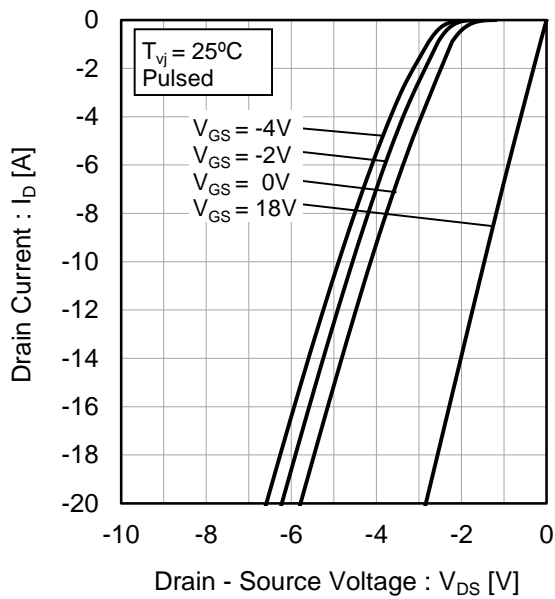


Fig.6  $T_{vj} = 25^\circ\text{C}$  3rd Quadrant Characteristics



●Electrical characteristic curves

Fig.7  $T_{vj} = 150^{\circ}\text{C}$  Typical Output Characteristics(I)

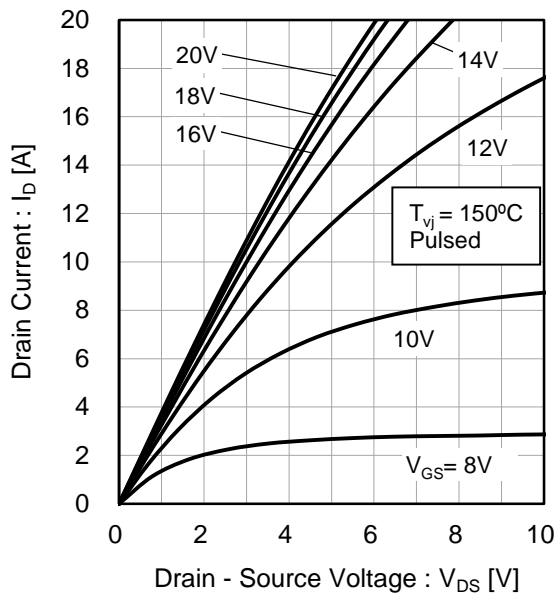


Fig.8  $T_{vj} = 150^{\circ}\text{C}$  Typical Output Characteristics(II)

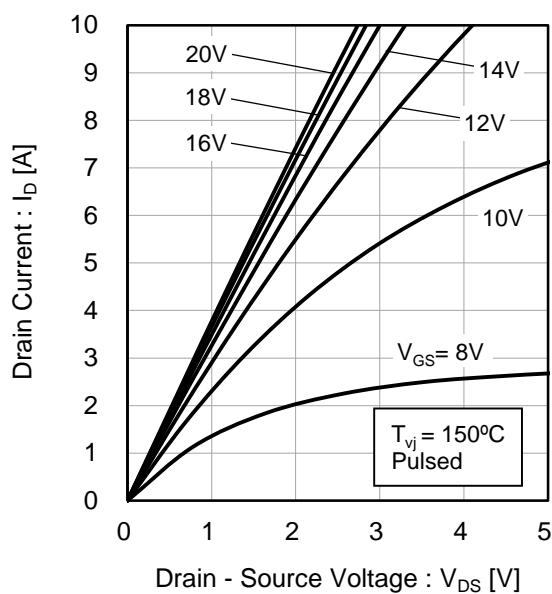


Fig.9  $T_{vj} = 150^{\circ}\text{C}$  3rd Quadrant Characteristics

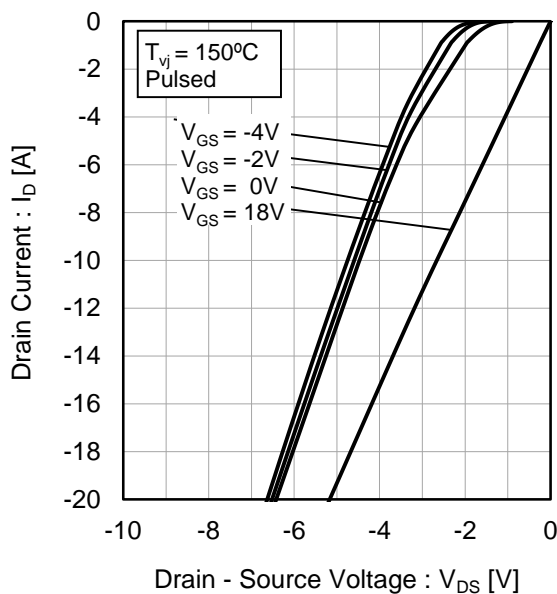
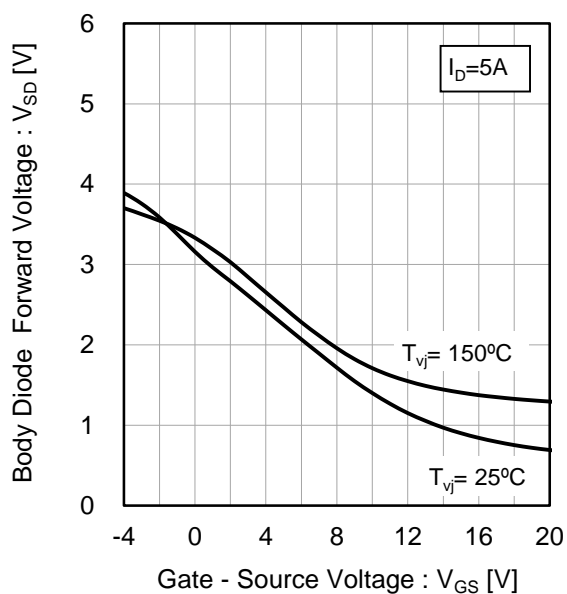


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage



●Electrical characteristic curves

Fig.11 Typical Transfer Characteristics (I)

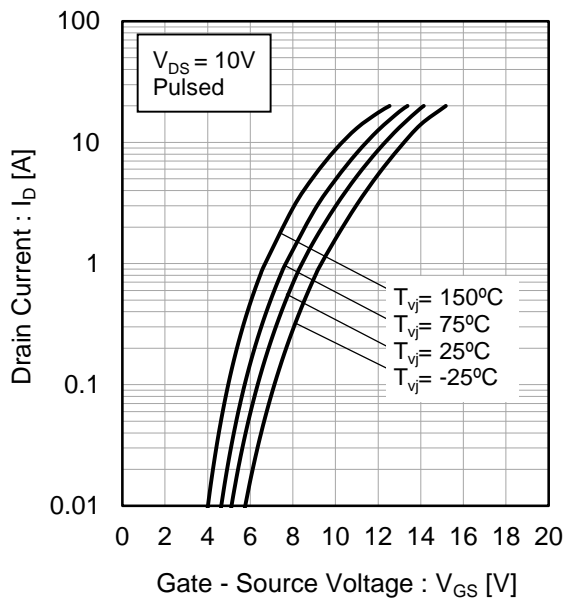


Fig.12 Typical Transfer Characteristics (II)

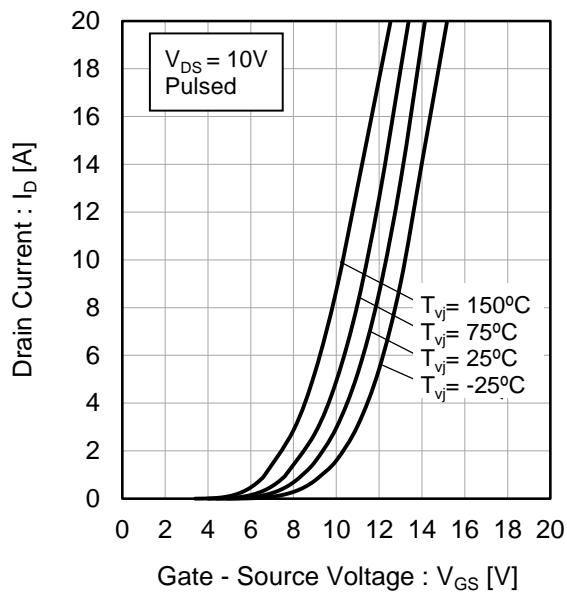


Fig.13 Gate Threshold Voltage vs. Junction Temperature

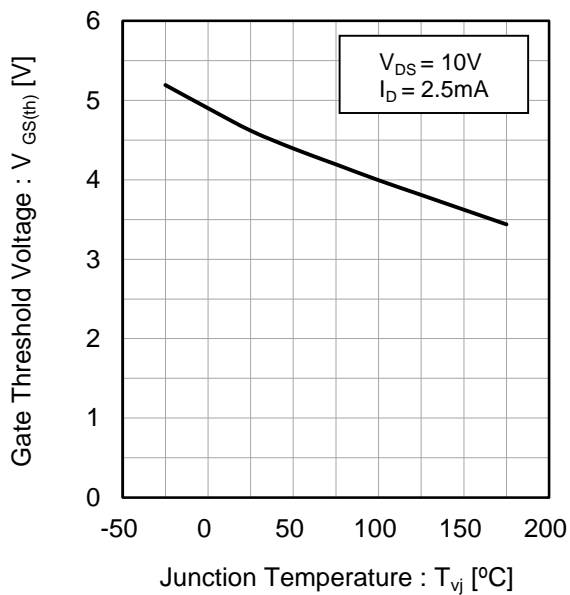
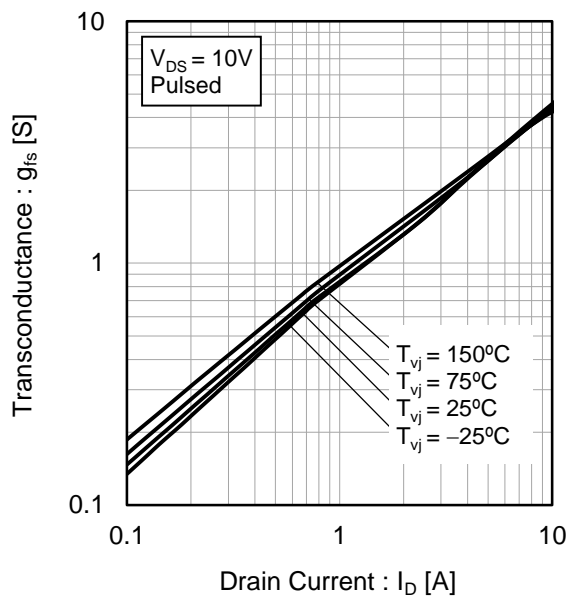


Fig.14 Transconductance vs. Drain Current





●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Gate - Source Voltage

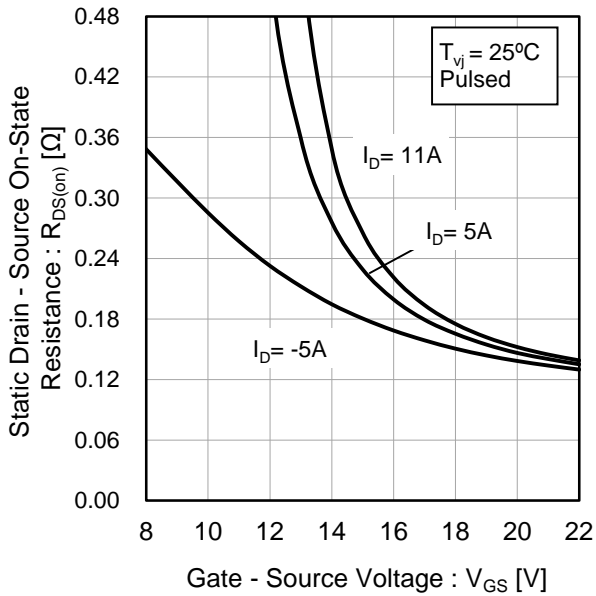


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature

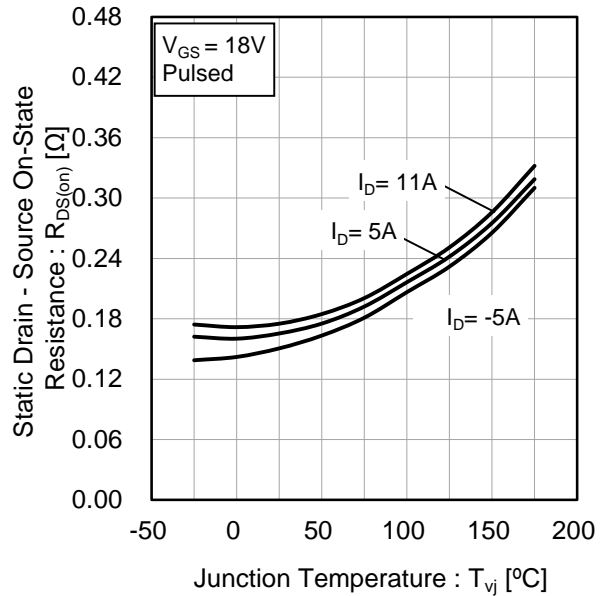


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current

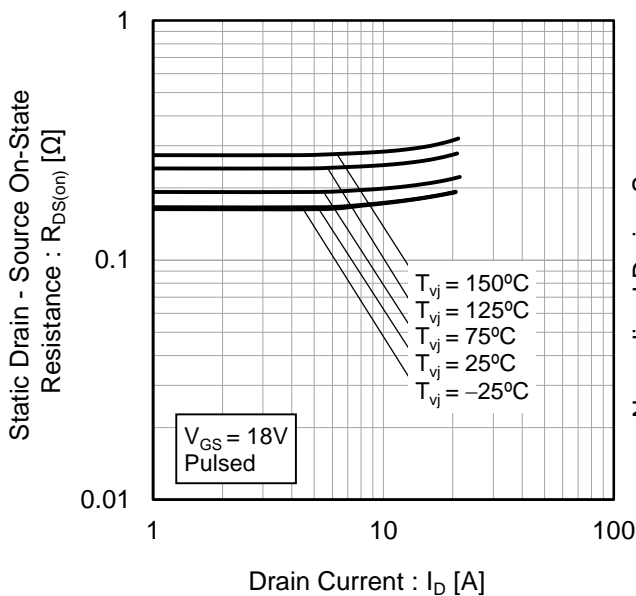
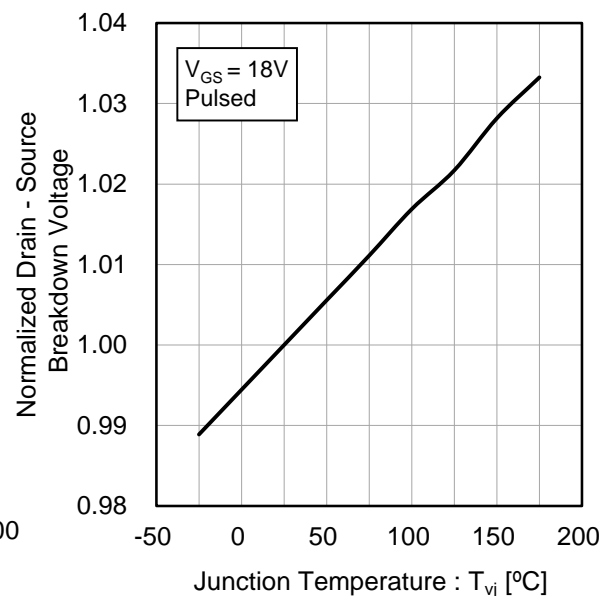


Fig.18 Normalized Drain - Source Breakdown Voltage vs. Junction Temperature



●Electrical characteristic curves

Fig.19 Typical Capacitance vs. Drain - Source Voltage

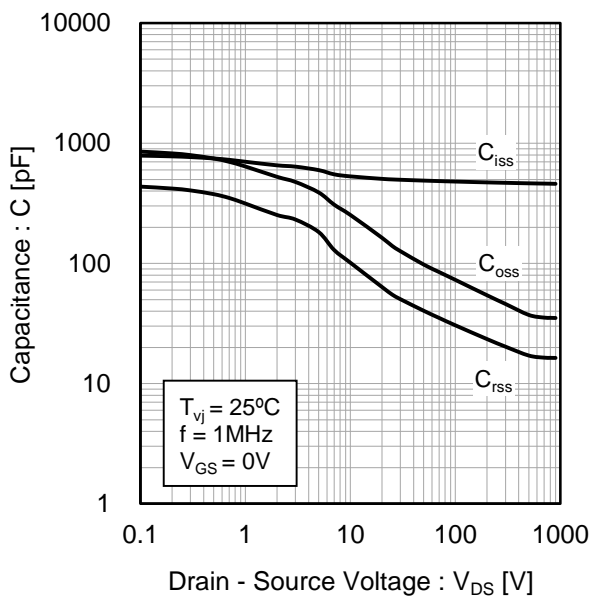


Fig.20  $C_{oss}$  Stored Energy

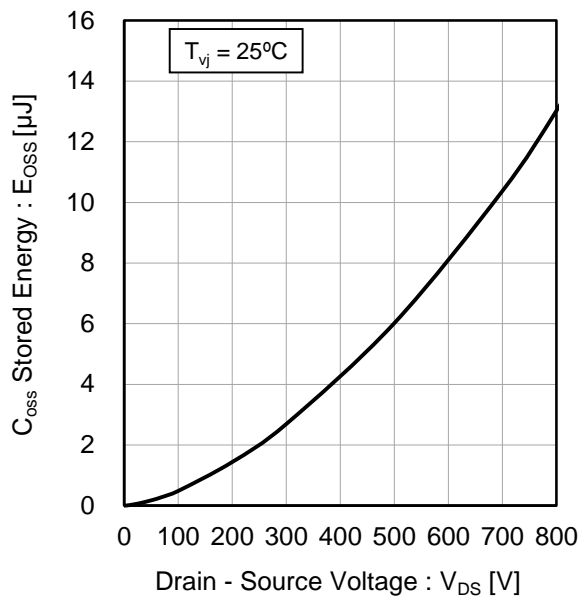
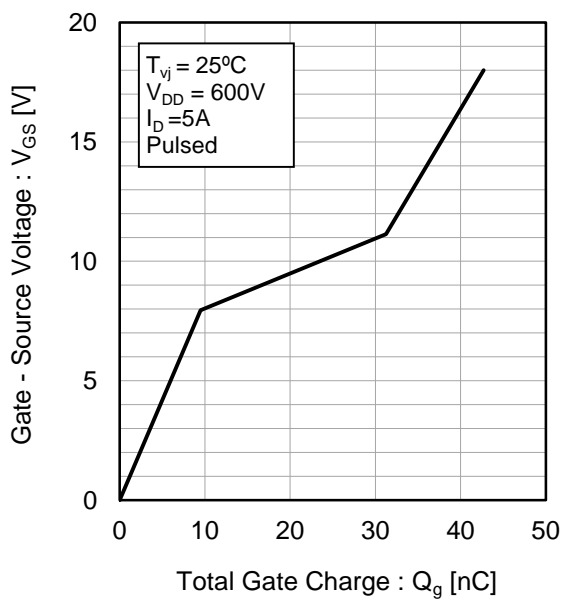
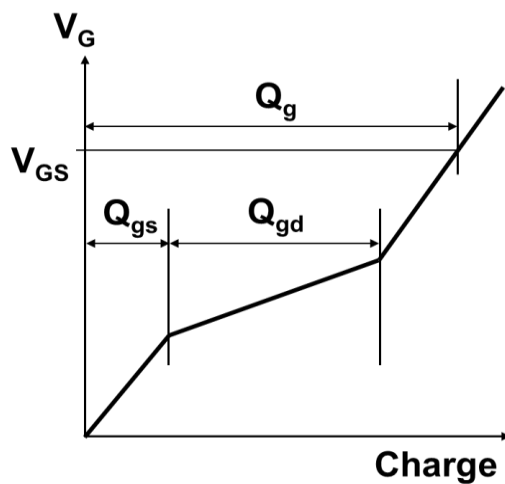


Fig.21 Dynamic Input Characteristics



\*Gate Charge Waveform



●Electrical characteristic curves

Fig.19 Typical Switching Time vs. Drain Current

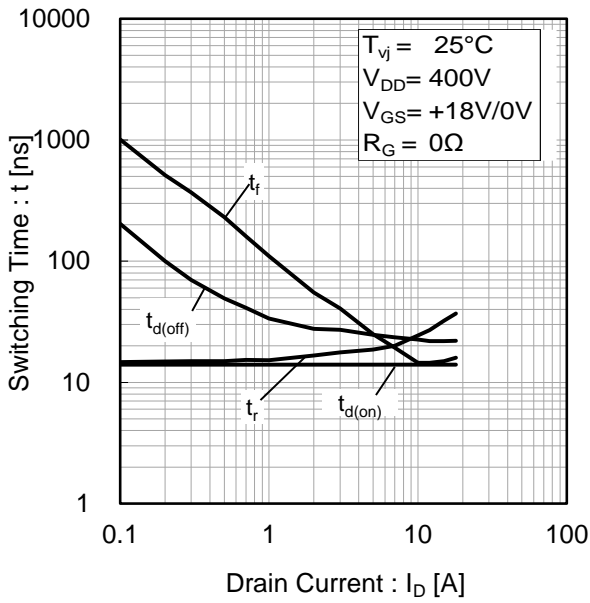


Fig.20 Typical Switching Loss vs. Drain - Source Voltage

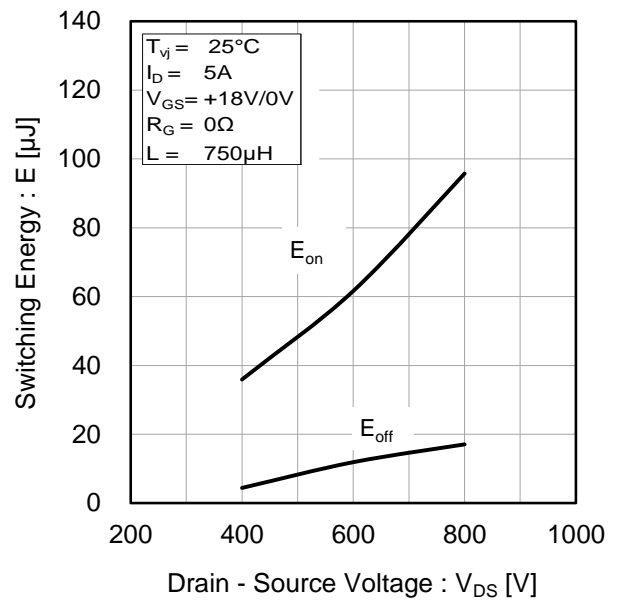


Fig.21 Typical Switching Loss vs. Drain Current

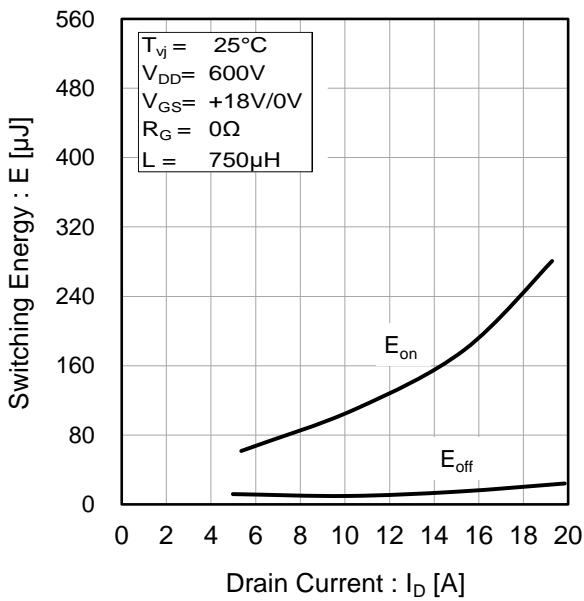
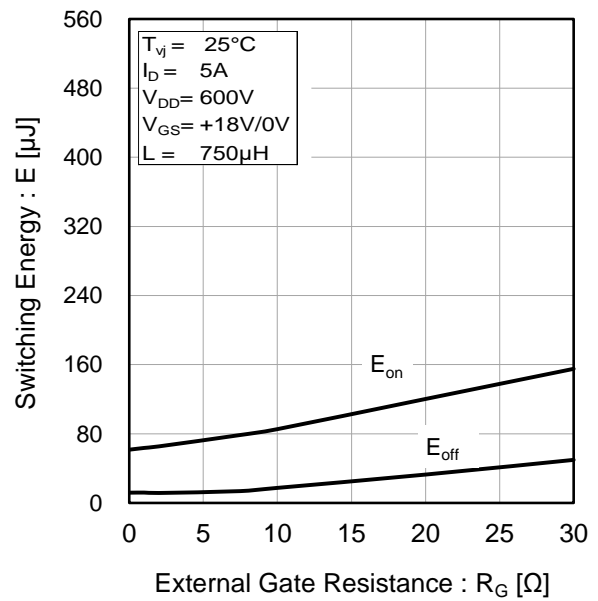


Fig.22 Typical Switching Loss vs. External Gate Resistance



● Measurement circuits and waveforms

Fig.1-1 Gate Charge and Switching Time Measurement Circuit

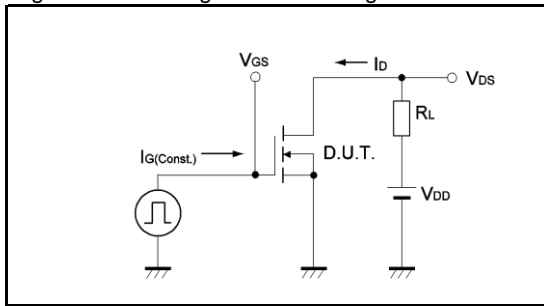


Fig.1-2 Waveforms for Switching Time

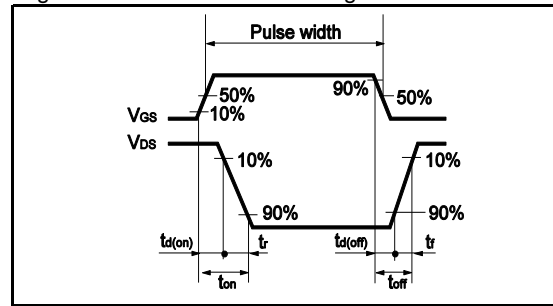


Fig.2-1 Switching Energy Measurement Circuit

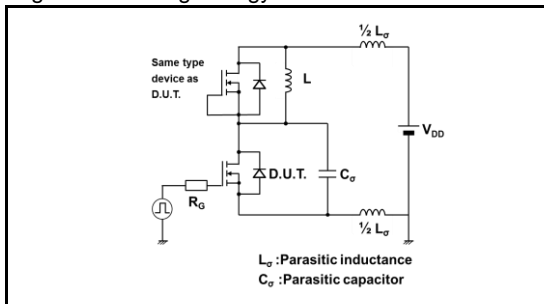


Fig.2-2 Waveforms for Switching Energy Loss

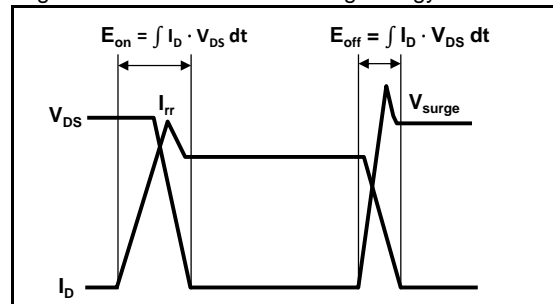


Fig.3-1 Reverse Recovery Time Measurement Circuit

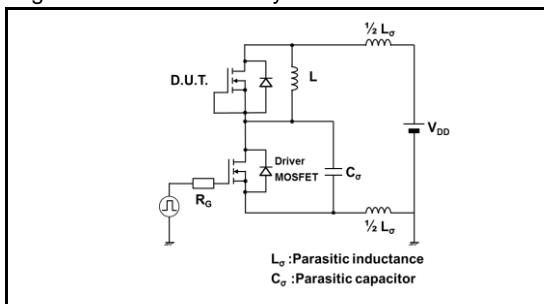
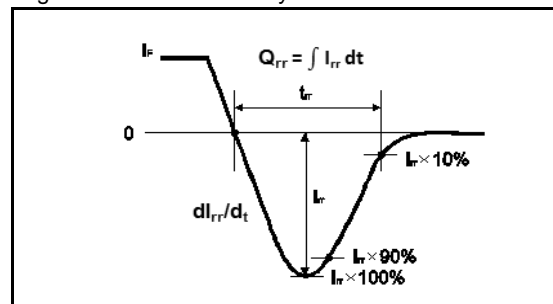
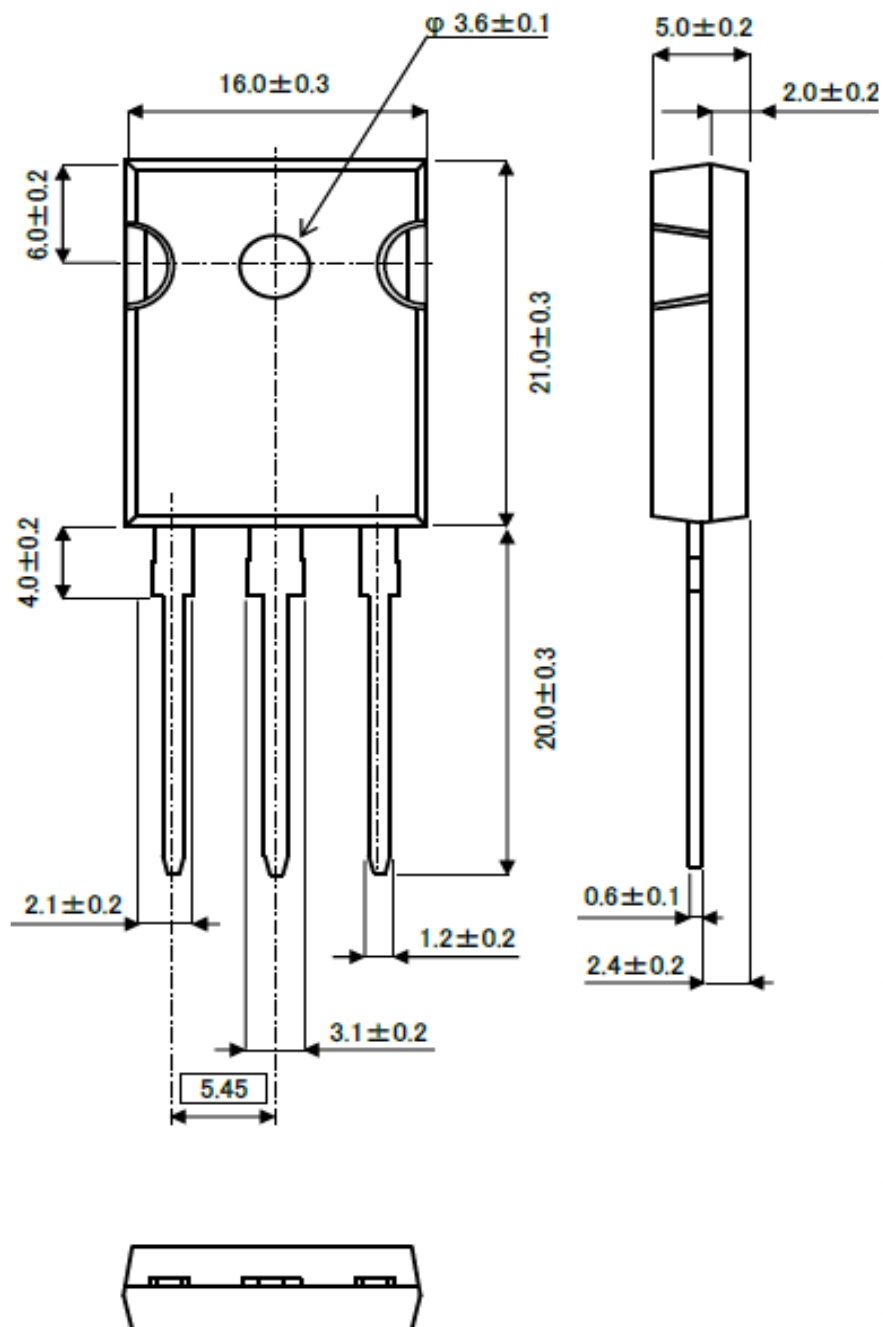


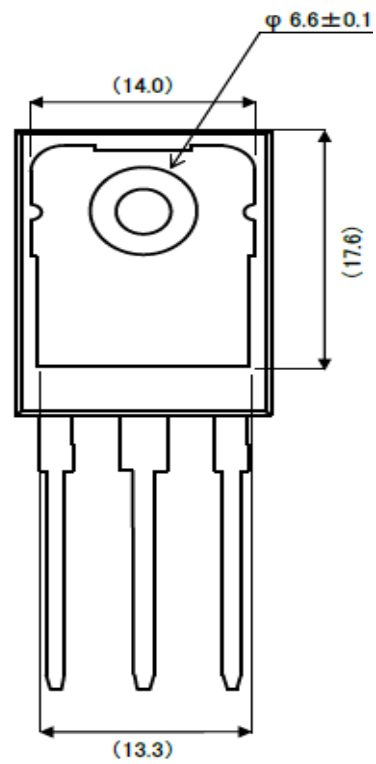
Fig.3-2 Reverse Recovery Waveform



## ●Package Dimensions

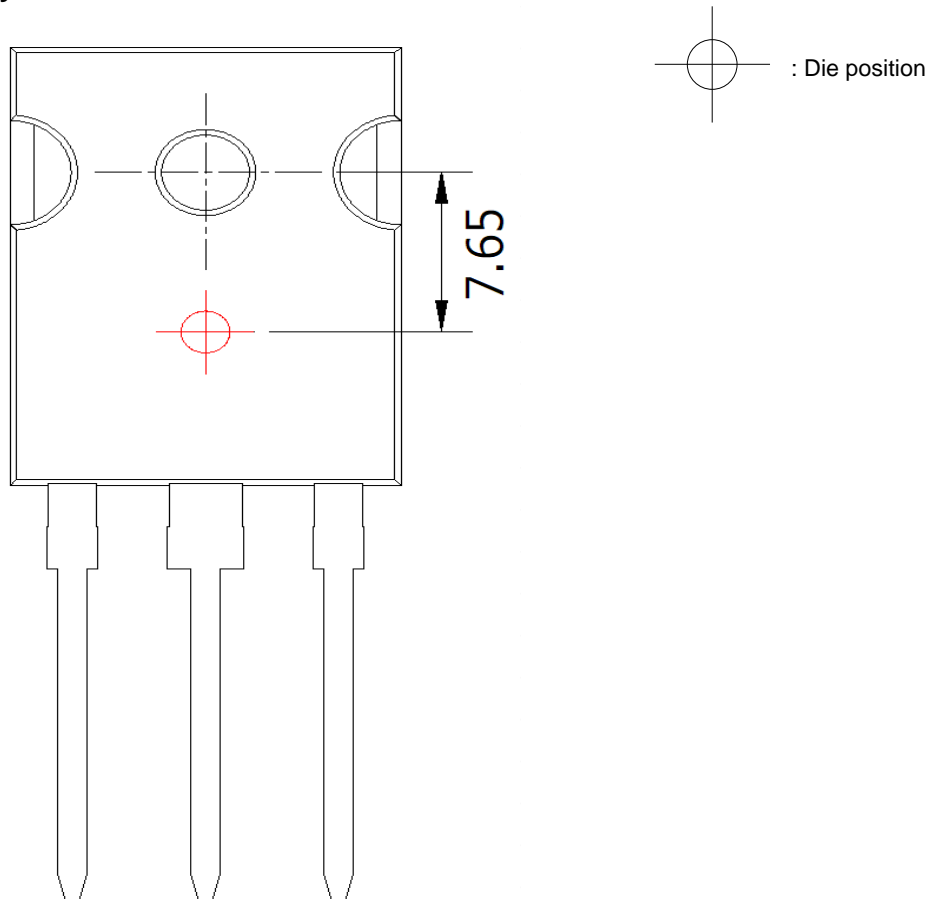


Unit: mm



Unit: mm

## ●Die Bonding Layout



- Front view of the packaging.
- Dimensions are design values.
- If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm

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